

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Field device integration (FDI) –
Part 101-2: Profiles – Foundation Fieldbus HSE**

**Intégration des appareils de terrain (FDI) –
Partie 101-2: Profils – Foundation Fieldbus HSE**

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FIELD DEVICE INTEGRATION (FDI) –

Part 101-2: Profiles – Foundation Fieldbus HSE

FOREWORD

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International Standard IEC 62769-101-2 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.

This second edition cancels and replaces the first edition published in 2015. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) support for generic protocol extension for faster adoption of other technologies;
- b) support for Package developers to build EDDs targeted for today's EDD bases system under a single development tool.

The text of this International Standard is based on the following documents:

CDV	Report on voting
65E/621/CDV	65E/684/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

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